IGBT Module

STARPOWER

SEMICONDUCTOR

IGBT

GD75FFT120C5SN

Molding Type Module

1200V/75A 6 in one-package

General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.



Features

- Low V_{CE(sat)} trench IGBT technology
- 10µs short circuit capability
- $V_{CE(sat)}$ with positive temperature coefficient
- Maximum junction temperature 175 °C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

Symbol	Description	GD75FFT120C5SN	Units
V _{CES}	Collector-Emitter Voltage	1200	V
V _{GES}	Gate-Emitter Voltage	±30	V
т	Collector Current @ $T_C=25^{\circ}C$	120	٨
I _C	@ T _C =100°C	75	А
I _{CM}	Pulsed Collector Current t _p =1ms	150	Α
$I_{\rm F}$	Diode Continuous Forward Current	75	Α
I _{FM}	Diode Maximum Forward Current t _p =1ms	150	Α
P _D	Maximum Power Dissipation @ $T_j=175^{\circ}C$	441	W
T _{jmax}	Maximum Junction Temperature	175	°C
T _{jop}	Operating Junction Temperature	-40 to +150	°C
T _{STG}	Storage Temperature Range	-40 to +125	°C
V _{ISO}	Isolation Voltage RMS,f=50Hz,t=1min	4000	V
Mounting Torque	Mounting Screw:M5	3.0 to 6.0	N.m
Weight	Weight of Module	200	g

Absolute Maximum Ratings $T_C=25$ °C unless otherwise noted

Electrical Characteristics of IGBT $T_C=25$ °C unless otherwise noted

Off Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	T _j =25°C	1200			V
I _{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0V,$ $T_j=25^{\circ}C$			5.0	mA
I _{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0V,$ $T_j=25^{\circ}C$			400	nA

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Vol tage	$I_C=3.5$ mA, $V_{CE}=V_{GE}$, $T_j=25$ °C	5.0	6.0	7.5	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I_{C} =75A, V_{GE} =15V, T_{j} =25°C		2.00	2.45	V
		I_{C} =75A, V_{GE} =15V, T_{j} =125 °C		2.40	v	

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
t _{d(on)}	Turn-On Delay Time			240		ns
t _r	Rise Time			63		ns
t _{d(off)}	Turn-Off Delay Time	V _600VI _75A		220		ns
t _f	Fall Time	$V_{CC}=600V,I_{C}=75A,$ $R_{G}=10\Omega,V_{GE}=\pm15V,$		190		ns
Eon	Turn-On Switching Loss	$K_{G} = 1052, V_{GE} = \pm 13V,$ $T_{j} = 25^{\circ}C$		5.54		mJ
E _{off}	Turn-Off Switching Loss			3.10		mJ
t _{d(on)}	Turn-On Delay Time			241		ns
t _r	Rise Time			70		ns
t _{d(off)}	Turn-Off Delay Time			222		ns
t _f	Fall Time	$V_{CC} = 600 \text{ V}, I_C = 75 \text{ A},$		264		ns
Eon	Turn-On Switching Loss	$R_{G}=10\Omega, V_{GE}=\pm 15V, T_{j}=125 °C$		8.30		mJ
E _{off}	Turn-Off Switching Loss			4.47		mJ
C _{ies}	Input Capacitance			9.45		nF
C _{oes}	Output Capacitance	V_{CE} =30V,f=1MHz,		0.34		nF
C _{res}	Reverse Transfer Capacitance	V _{GE} =0V		0.23		nF
I _{SC}	SC Data	$\begin{array}{c} t_{P} \leq 10 \mu s, V_{GE} = 15 \text{ V}, \\ T_{j} = 125 ^{\circ} \text{C}, V_{CC} = 900 \text{ V}, \\ V_{CEM} \leq 1200 \text{ V} \end{array}$		720		А
L _{CE}	Stray Inductance			60		nH
R _{CC'+EE'}	Module Lead Resistance, Terminal To Chip			8.0		mΩ

Switching Characteristics

Electrical Characteristics of Diode $T_C=25$ °C unless otherwise noted

Symbol	Parameter	Test Condi	tions	Min.	Typ.	Max.	Units
V _F	Diode Forward	$I_{\text{F}}=75\text{A}, V_{\text{GE}}=0\text{V}$	T _j =25℃		1.65	2.05	V
V _F	Voltage	$I_F = 73A, V_{GE} = 0V$	T _j =125℃		1.65		v
0	Recovered		T _i =25℃		6.9		чС
Q_r	Charge	I _F =75A,	T _i =125℃		13.1		μC
I _{RM}	Peak Reverse	V _R =600V,	T _j =25℃		30		А
	Recovery Current	$R_G=4.7\Omega$,	T _j =125℃		40		A
E _{rec}	Reverse Recovery	V_{GE} =-15V	T _j =25℃		2.30		mJ
	Energy		T _j =125℃		4.73		1113

Thermal Characteristics

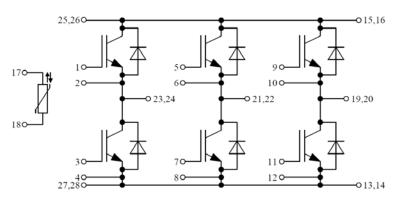
Symbol	Parameter	Тур.	Max.	Units
R _{0JC} Ju	nction-to-Case (per IGBT)		0.340	K/W
	nction-to-Case (per Diode)		0.569	K/W
R _{0CS} Ca	ase-to-Sink (Conductive grease applied)	0.02		K/W

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Preliminary

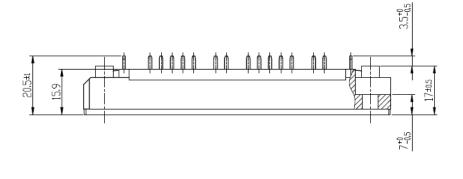
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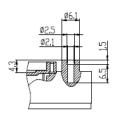
Equivalent Circuit Schematic

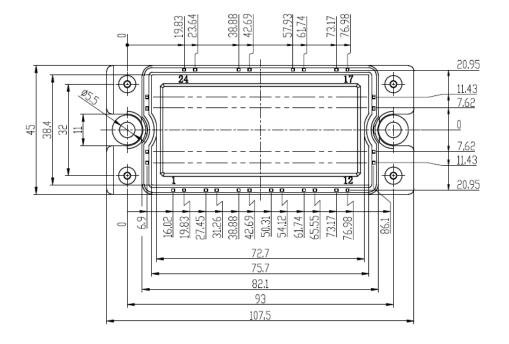


Package Dimensions

Dimensions in Millimeters







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